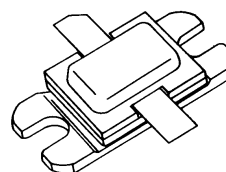


## RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

- REFRACTORY\GOLD METALLIZATION
- RUGGEDIZED VSWR 25:1
- INTERNAL INPUT/OUTPUT MATCHING
- LOW THERMAL RESISTANCE
- METAL/CERAMIC HERMETIC PACKAGE
- $P_{OUT} = 450 \text{ W MIN. WITH } 7.0 \text{ dB GAIN}$



**.400 x .500 2LFL (S038)**  
hermetically sealed

**ORDER CODE**  
MSC81450M

**BRANDING**  
81450M

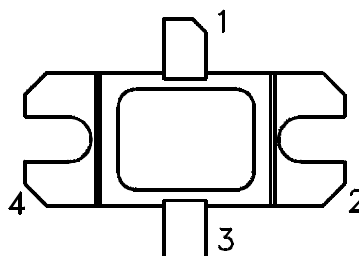
### DESCRIPTION

The MSC81450M device is a high power pulsed transistor specifically designed for IFF avionics applications.

This device is capable of withstanding a minimum 25:1 load mismatch at any phase angle under full rated conditions.

The MSC81450M is housed in the unique BIG-PAC™ package with internal input/output matching structures.

### PIN CONNECTION



- |              |            |
|--------------|------------|
| 1. Collector | 3. Emitter |
| 2. Base      | 4. Base    |

### ABSOLUTE MAXIMUM RATINGS ( $T_{case} = 25^{\circ}\text{C}$ )

Symbol	Parameter	Value	Unit
$P_{DISS}$	Power Dissipation*	910	W
$I_C$	Device Current*	28	A
$V_{CC}$	Collector-Supply Voltage*	55	V
$T_J$	Junction Temperature (Pulsed RF Operation)	250	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature	- 65 to +200	$^{\circ}\text{C}$

### THERMAL DATA

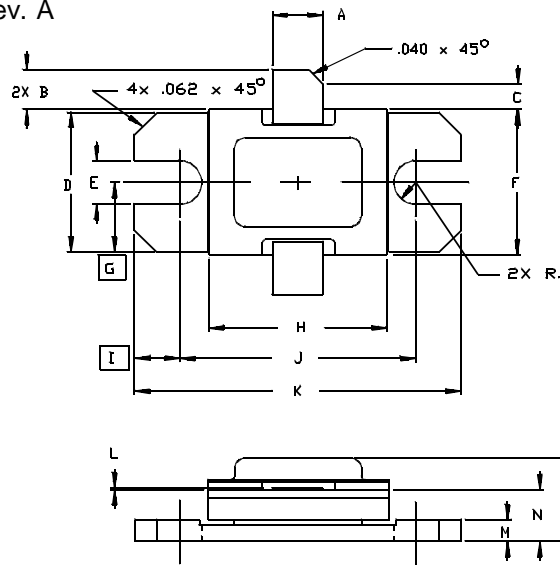
$R_{TH(j-c)}$	Junction-Case Thermal Resistance*	0.15	$^{\circ}\text{C/W}$
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\*Applies only to rated RF amplifier operation



## PACKAGE MECHANICAL DATA

Ref.: Dwg. No. 12-0212 rev. A



SGS-THOMSON MICROELECTRONICS			CONT'D		
	MINIMUM Inches/mm	MAXIMUM Inches/mm		MINIMUM Inches/mm	MAXIMUM Inches/mm
A	.135/3,43	.145/3,68	K	.890/22,61	.910/23,11
B	.100/2,54	.120/3,05	L	.003/0,08	.006/0,15
C	.050/1,27		M	.052/1,32	.072/1,83
D	.376/9,55	.396/10,06	N	.118/3,00	.131/3,33
E	.110/2,79	.130/3,30	P		.230/5,84
F	.395/10,03	.407/10,34			
G	.193/4,90				
H	.490/12,45	.510/12,95			
I	.100/2,54				
J	.690/17,53	.710/18,03			

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